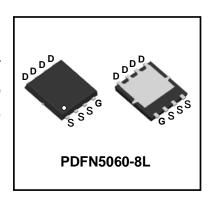


150V N-Channel Enhancement Mode Power MOSFET

Description

WMB198N15HG2 uses Wayon's 2nd generation power trench MOSFET technology that has been especially tailored to minimize the on-state resistance and yet maintain superior switching performance. This device is well suited for high efficiency fast switching applications.



Features

- $V_{DS} = 150V$, $I_D = 47A$ (Silicon Limited) $R_{DS(on)} < 19.8m\Omega$ @ $V_{GS} = 10V$
- Green Device Available
- 100% EAS Guaranteed
- Low Gate Charge
- High Speed Power Switching

Applications

- Synchronous Rectification in SMPS
- Hard Switching and High Speed Circuit
- DC/DC Converter

Absolute Maximum Ratings

Parameter		Symbol	Value	Unit	
Drain-Source Voltage		V _{DS}	150	V	
Gate-Source Voltage		V _{GS}	±20	V	
Continuous Drain Current ¹ (Silicon Limited)	Tc=25°C	- I _D	47		
	T _C =100°C		30.5	А	
Pulsed Drain Current ²		I _{DM}	129	Α	
Single Pulse Avalanche Energy ³		EAS	156.8	mJ	
Avalanche Current		I _{AS}	28	Α	
Total Power Dissipation ⁴	Tc=25°C	P _D	97.6	W	
Operating Junction and Storage Temperature Range		TJ, TSTG	-55 to 150	°C	

Thermal Characteristics

Parameter	Symbol	Value	Unit
Thermal Resistance from Junction-to-Ambient ¹	R _{0JA}	51	°C/W
Thermal Resistance from Junction-to-Case ¹	Rejc	1.28	°C/W



Electrical Characteristics T_c = 25°C, unless otherwise noted

Parameter		Symbol	Test Conditions	Min.	Тур.	Max.	Unit	
Static Characteristics						·		
Drain-Source Breakdown Voltage		V _{(BR)DSS}	$V_{GS} = 0V, I_D = 250\mu A$		-	-	V	
Gate-Body Leakage Current		I _{GSS}	$V_{DS} = 0V$, $V_{GS} = \pm 20V$	-	-	±100	nA	
Zero Gate Voltage Drain Current	T _J =25°C	IDSS	V _{DS} = 150V, V _{GS} = 0V	-	-	1	μА	
	T _J =100°C			-	-	100		
Gate-Threshold Voltage		V _{GS(th)}	$V_{DS} = V_{GS}$, $I_D = 250\mu A$	2	3	4	V	
Drain-Source on-Resistance ²		R _{DS(on)}	V _{GS} = 10V, I _D = 20A	-	17.3	19.8	mΩ	
Forward Transconductance ²	!	g fs	V _{DS} = 5V, I _D = 20A	-	56	-	S	
Dynamic Characteristic	s	l		I		l	I	
Input Capacitance		C _{iss}		-	2150	-		
Output Capacitance		Coss	C oss V _{DS} = 75V, V _{GS} =0V, f =1MHz		145	-	pF	
Reverse Transfer Capacitan	ce	Crss		-	12	-		
Switching Characteristic	cs	l				l	I	
Gate Resistance		R _G	V _{DS} = 0V, V _{GS} =0V, f =1MHz	-	2	-	Ω	
Total Gate Charge Gate-Source Charge		Qg	V _{GS} = 10V, V _{DS} = 75V, I _D = 20A	-	28	-	nC	
		Q _{gs}		-	12.2	-		
Gate-Drain Charge		Q _{gd}		-	4.5	-		
Turn-on Delay Time		t _{d(on)}			10.2	-		
Rise Time Turn-off Delay Time		t _r	$V_{GS} = 10V, V_{DS} = 75V,$ $R_{G} = 10\Omega, I_{D} = 20A$	-	8.8	-	nS	
		t _{d(off)}		-	16	-		
Fall Time		t _f		-	10	-		
Drain-Source Body Dioc	de Charact	eristics		I		l	I	
Diode Forward Voltage ²		V _{SD}	Is = 1A, V _{GS} = 0V	-	-	1	V	
Continuous Source Current ^{1,5}		Is	V _G =V _D =0V , Force Current	-	-	47	Α	
Body Diode Reverse Recovery Time		t _{rr}	V _R = 75V ,I _F = 20A,	-	65	-	nS	
Body Diode Reverse Recovery Charge		Q _{rr}	$dI/dt = 100A/\mu s$	-	125	-	nC	

Notes:

- 1. The data tested by surface mounted on a 1 inch 2 FR-4 board with 2OZ copper.
- 2.The data tested by pulsed , pulse width $\leq 300 us$, duty cycle $\leq 2\%$
- 3. The EAS data shows Max. rating . The test condition is V_{DD} =25V, V_{GS} =10V, L=0.4mH, I_{AS} =28A
- 5. The data is theoretically the same as I_D and I_{DM} , in real applications, should be limited by total power dissipation.



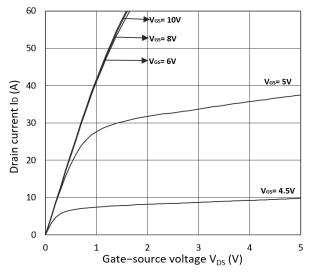


Figure 1. Output Characteristics

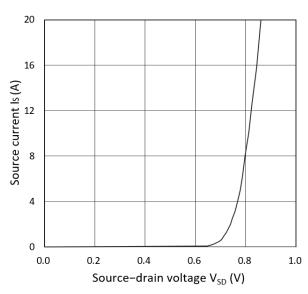


Figure 3. Forward Characteristics of Reverse

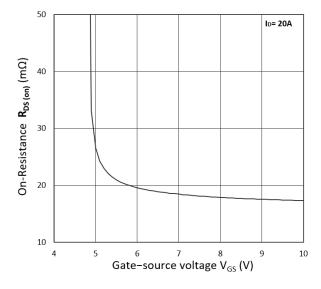
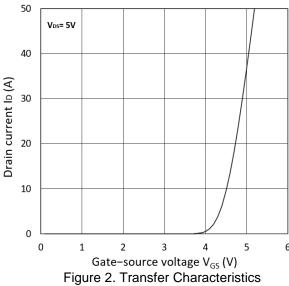


Figure 5. RDS(ON) vs. VGS



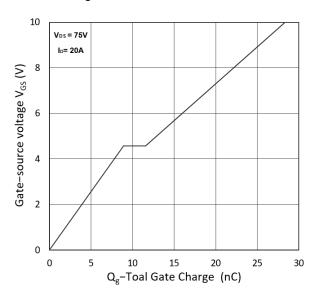


Figure 4. Gate Charge Characteristics

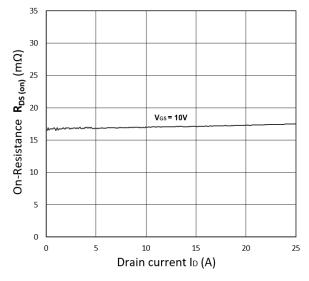


Figure 6. RDS(ON) vs. ID



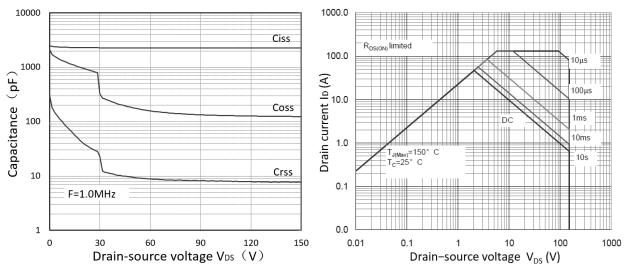


Figure 7. Capacitance Characteristics

Figure 8. Safe Operating Area

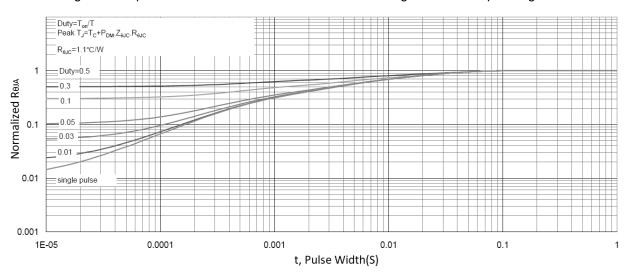


Figure 9. Normalized Maximum Transient Thermal Impedance

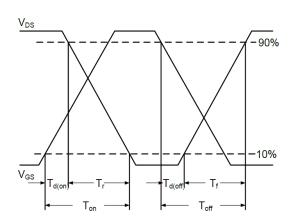


Figure 10. Switching Time Waveform

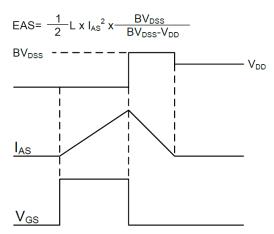
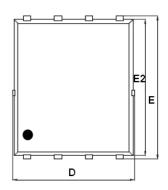


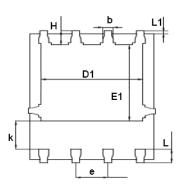
Figure 11. Unclamped Inductive Switching

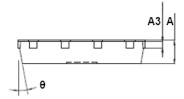
Waveform



Mechanical Dimensions for PDFN5060-8L







COMMON DIMENSIONS

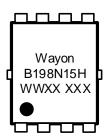
	MM			
SYMBOL	MIN	MAX		
Α	0.90	1.20		
А3	0.15	0.35		
D	4.80	5.40		
Е	5.90	6.35		
D1	3.61	4.31		
E1	3.30	3.92		
E2	5.65	6.06		
k	1.10	-		
b	0.30	0.51		
е	1.27BSC			
L	0.38	0.71		
L1	0.05	0.36		
Н	0.38	0.61		
θ	0°	12°		



Ordering Information

Part Package		Marking	Packing method	
WMB198N15HG2	PDFN5060-8L	B198N15H	Tape and Reel	

Marking Information



B198N15H = Device code

WWXX XXX= Date code

Contact Information

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WAYON website: http://www.way-on.com

For additional information, please contact your local Sales Representative.

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